

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
MOHAWK INTERNATIONAL HOLDINGS (DE), LLC	04/06/2023
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<b>PROPERTY NUMBERS Total: 12</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15571576
Application Number:	16808745
Application Number:	17374390
Application Number:	17374412
Application Number:	17374356
Application Number:	17374431
Application Number:	17374448
Application Number:	17504781
Application Number:	17504787
Application Number:	17518748
Application Number:	18182510
Application Number:	18192867
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<b>ATTORNEY DOCKET NUMBER:</b>	19791.179
<b>NAME OF SUBMITTER:</b>	JUSTIN J. CASSELL
<b>SIGNATURE:</b>	/Justin J. Cassell/
<b>DATE SIGNED:</b>	05/15/2023
<b>Total Attachments: 3</b> source=19791-179_MIHDE-to-MGI_Assignment#page1.tif source=19791-179_MIHDE-to-MGI_Assignment#page2.tif source=19791-179_MIHDE-to-MGI_Assignment#page3.tif	

ASSIGNMENT

This assignment is directed to:

- ☐ The application for United States Letters Patent executed on even date herewith;
- ☐ United States patent number \_\_\_\_\_ granted on \_\_\_\_\_ ;
- ☐ United States application or Patent Cooperative Treaty international application number: \_\_\_\_\_ filed on \_\_\_\_\_
- ☒ The document(s) provided in SCHEDULE A submitted herewith, including U.S. and foreign patent(s) and application(s) executed on even date herewith;

WHEREAS, **Mohawk International Holdings (DE), LLC** a corporation with its principal place of business at 160 South Industrial Blvd., Calhoun, Georgia 30701, hereinafter referred to as ASSIGNOR, is the or an owner of certain new and useful improvements in the document(s) (hereinafter, collectively if necessary, referred to as the INVENTION).

WHEREAS, **Mohawk Global Investments S.à.r.l.**

whose post office address is/are **10B, rue des Mérovingiens, L-8070 Bertrange, Luxembourg**

hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in and to the INVENTION in the United States and outside the United States;


NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I, ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application(s) throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application; and the entire right, title and interest in and to the said INVENTION throughout the world, including the right to apply for patents and inventor certificates in respect thereof and to claim priority pursuant to rights accorded ASSIGNOR under the terms of the Paris International Convention and all other available international conventions and treaties; and the entire right, title and interest in and to any and all patents, patents of addition, utility models, patents of importation, revalidation patents and inventor certificates which may be granted throughout the world in respect of said INVENTION

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) or inventor certificate(s) in the United States and outside the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify

and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the INVENTION that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents of the United States Patent and Trademark Office to issue any and all Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behoof; and for the use and behoof of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

ASSIGNOR authorizes any individual authorized to act on behalf of Customer Number 22913 to insert or complete any information in this document needed to effect its recordal in the United States Patent and Trademark Office.

LEGAL NAME OF ASSIGNOR			
Name:	<b>Valerie BARNEY</b> <b>Title: Assistant Secretary</b>	Date:	06/04/2023
Signature:			

**SCHEDULE A**

<b>Country</b>	<b>Serial No. / Patent No.</b>	<b>Filed / Issued</b>	<b>Title</b>
U.S.	15/571,576	11/3/2017	FLOOR BOARD AND METHOD FOR MANUFACTURING SUCH FLOOR BOARDS
U.S.	16/808,745	3/4/2020	FLOOR BOARD AND METHOD FOR MANUFACTURING SUCH FLOOR BOARDS
U.S.	17/374,390	7/13/2021	FLOOR BOARD AND METHOD FOR MANUFACTURING SUCH FLOOR BOARDS
U.S.	17/374,412	7/13/2021	FLOOR BOARD
U.S.	17/374,356	7/13/2021	FLOOR BOARD AND METHOD FOR MANUFACTURING SUCH FLOOR BOARDS
U.S.	17/374,431	7/13/2021	FLOOR BOARD AND METHOD FOR MANUFACTURING SUCH FLOOR BOARDS
U.S.	17/374,448	7/13/2021	FLOOR BOARD AND METHOD FOR MANUFACTURING SUCH FLOOR BOARDS
U.S.	17/504,781	10/19/2021	FLOOR BOARD AND METHOD FOR MANUFACTURING SUCH FLOOR BOARDS
U.S.	17/504,787	10/19/2021	FLOOR BOARD AND METHOD FOR MANUFACTURING SUCH FLOOR BOARDS
U.S.	17/518,748	11/4/2021	FLOOR BOARD AND METHOD FOR MANUFACTURING SUCH FLOOR BOARDS
U.S.	18/182,510	03/13/2023	FLOOR BOARD AND METHOD FOR MANUFACTURING SUCH FLOOR BOARDS
U.S.	18/192,867	03/30/2023	FLOOR BOARD AND METHOD FOR MANUFACTURING SUCH FLOOR BOARDS